FOR!: PTO-1595 (Modified) (Rev. 03-01) OMB No. 0651-0027 (exp.5/31/2002) P08A/REV03 02-26-2002



locket No.: FP01-340US

U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office

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	93)30 ,
To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.	
Name of conveying party(ies): Hideto Nakamura	2. Name and address of receiving party(ies): Name: Sumitomo Wiring Systems, Ltd. Address: 1-14, Nishisuchiro-cho
Additional names(s) of conveying party(ies)	in the second se
3. Nature of conveyance:	
🛮 Assignment 🔲 Merger	
☐ Security Agreement ☐ Change of Name	City: Yokkaichi-City State/Prov.: Mie
☐ Other	Country: Japan ZIP: 510-8503
Execution Date: January 15, 2002	Additional name(s) & address(es) ☐ Yes ☒ No
Application number(s) or patent numbers(s):	
If this document is being filed together with a new application,	the execution date of the application is: January 15, 2002
Patent Application No. Filing date	B. Patent No.(s)
	10/074485
Additional numbers	☐ Yes 🛛 No
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Gerald E. Hespos	7. Total fee (37 CFR 3.41):\$ 40.00
Registration No. 30,066 Address: 274 Madison Avenue - Suite 1703	☑ Enclosed - Any excess or insufficiency should be credited or debited to deposit account
	☐ Authorized to be charged to deposit account
	8. Deposit account number:
City: New York State/Prov.: NY	03-1030
Country: U.S.A. ZP: 10016	(Attach duplicate copy of this page if paying by deposit account)
FC:581 40.00 0P DO NOT USE THIS SPACE	
9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.	
Gerald E. Hespos	February 12, 2002
Name of Person Signing Total number of pages including of	Signature / Date 2

Atty. Ref.: FP01-340US

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned by the Assignee, Sumitomo Wiring Systems, Ltd., a corporation organized under the laws of Japan, located at 1-14, Nishisuehiro-cho, Yokkaichi-City, Mie, 510-8503, Japan, receipt whereof is hereby acknowledged, the undersigned by these presents hereby sells, assigns, transfers and sets over unto the said assignee the entire right, title and interest in and to the invention or improvement entitled "A CONNECTOR AND METHOD FOR ASSEMBLING A CONNECTOR", said invention being fully described and/or claimed in the application for Letters Patent of the United States of America, executed this date, in and for the United States and all foreign countries, the same to be held and enjoyed by said assignee, its successors, assigns or other legal representatives, to the full ends of the terms for which all Letters Patent therefor may be granted, as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

And Said Assignee Is Hereby Authorized to make application for and to receive Letters Patent for said invention in any of said countries at its election.

And By This Covenant The Undersigned will execute or procure any further necessary assurance of title to said invention and Letters Patent; and at any time, upon the request and at the expense of said assignee, will execute and deliver any and all papers that may be necessary or desirable to perfect the title to said invention or any Letters Patents which may be granted therefor in said Assignee, its successors, assigns or other legal representatives, and, upon the request and at the expense of said assignee, will execute any additional or divisional applications for patents for said invention, or any part or parts thereof, and for the reissue of any Letters Patents to be granted therefor, and will make all rightful oaths and do all lawful acts requisite for procuring the same or for aiding therein, without further compensation, but at the expense of said assignee, its successors, assigns or other legal representatives.

And The Commissioner Of Patents Is Hereby Authorized And Requested to issue any and all Letters Patent of the United States for said invention, to said assignee.

Signed and sealed this _______, day of <u>January</u>______, 2002.

RECORDED: 02/12/2002

Hidero Nakamus L.S.

PATENT

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